

**Features:**

- Isolated mounting base 3000V~
- Pressure contact technology with Increased power cycling capability
- Space and weight saving

Typical Applications

- Various rectifiers
- DC supply for PWM inverter

V_{RRM}	Type & Outline		
	2000V	2200V	2500V
	MDx110-20-223F3	MDx110-22-223F3	MDx110-25-223F3
			MD110-25-223F3G

MDx stands for any type of **MDC**, **MDA**, **MDK**

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T_j (°C)	VALUE			UNIT
				Min	Type	Max	
$I_{F(AV)}$	Mean forward current	180° half sine wave 50Hz Single side cooled, $T_c=100^\circ\text{C}$	150			110	A
$I_{F(RMS)}$	RMS forward current					173	A
I_{RRM}	Repetitive peak current	at V_{RRM}	150			8	mA
I_{FSM}	Surge forward current	$V_R=60\%V_{RRM}$, $t=10\text{ms}$ half sine	150			2.6	kA
I^2t	I^2t for fusing coordination					33	$10^3\text{A}^2\text{s}$
V_{FO}	Threshold voltage		150			0.85	V
r_F	Forward slope resistance					1.88	$\text{m}\Omega$
V_{FM}	Peak forward voltage	$I_{FM}=330\text{A}$	25			1.55	V
$R_{th(j-c)}$	Thermal resistance Junction to case	Single side cooled per chip				0.29	$^\circ\text{C}/\text{W}$
$R_{th(c-h)}$	Thermal resistance case to heatsink	Single side cooled per chip				0.20	$^\circ\text{C}/\text{W}$
V_{iso}	Isolation voltage	50Hz,R.M.S., $t=1\text{min}$, $I_{iso}:1\text{mA}(\text{MAX})$		3000			V
F_m	Terminal connection torque(M5)			2.5		4.0	$\text{N}\cdot\text{m}$
	Mounting torque(M6)			4.5		6.0	$\text{N}\cdot\text{m}$
T_{vj}	Junction temperature			-40		150	$^\circ\text{C}$
T_{stg}	Stored temperature			-40		125	$^\circ\text{C}$
W_t	Weight				320		g
Outline				223F3			

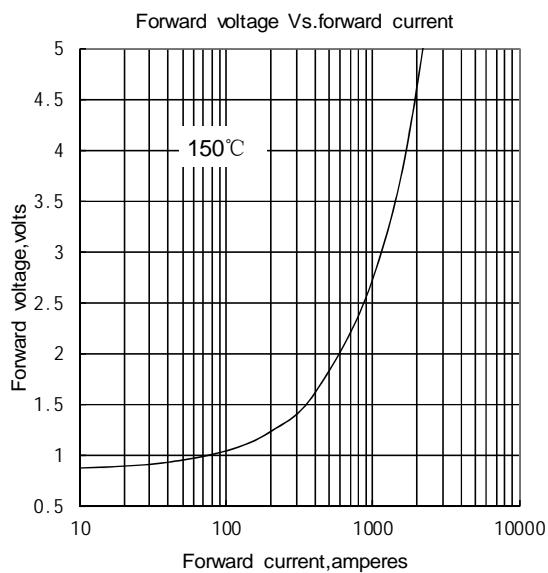


Fig.1

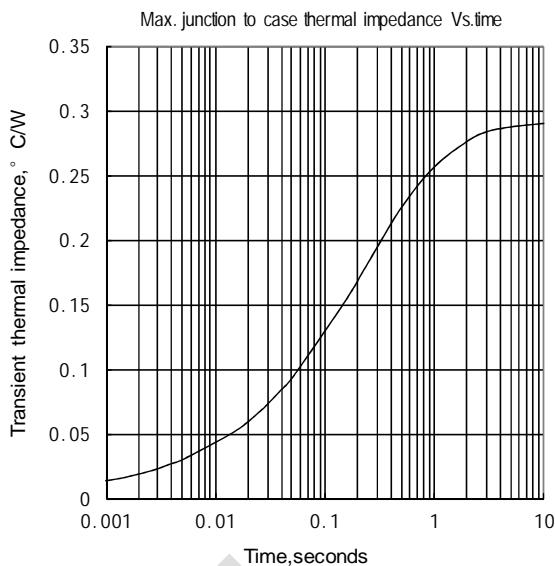


Fig.2

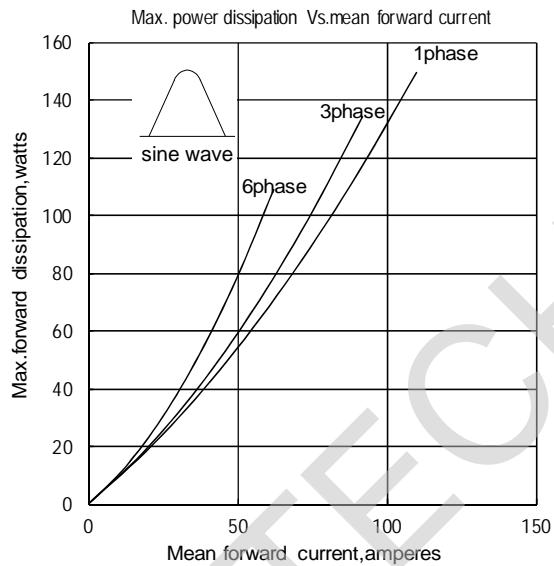


Fig.3

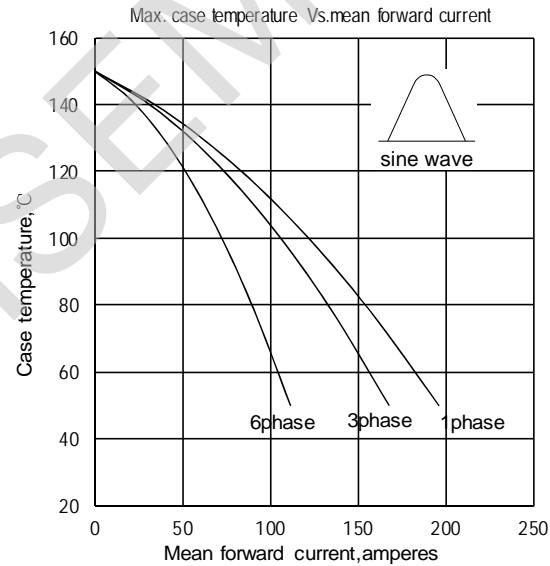


Fig.4

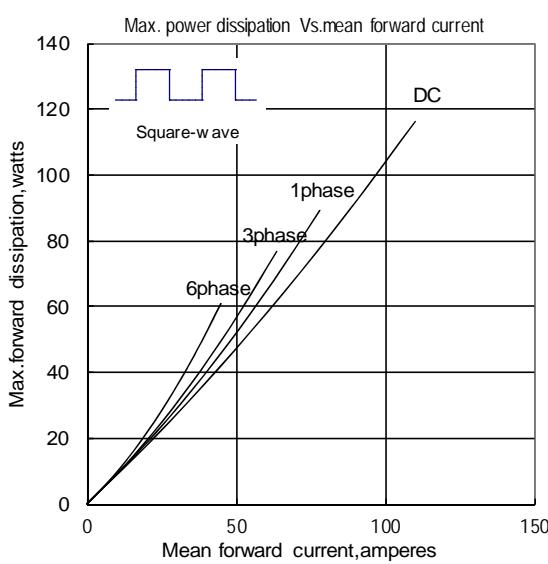


Fig.5

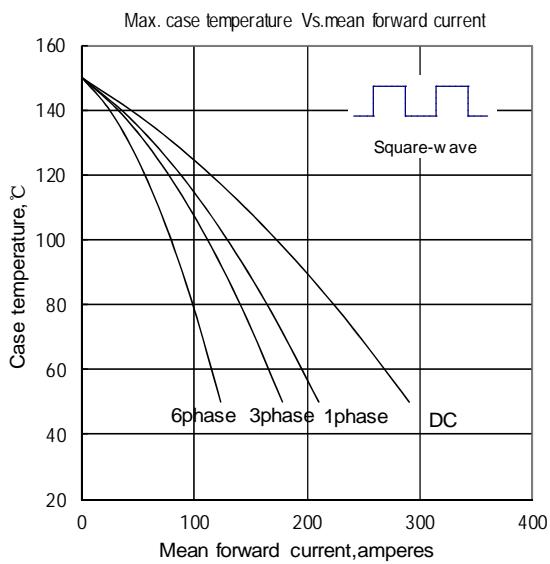


Fig.6

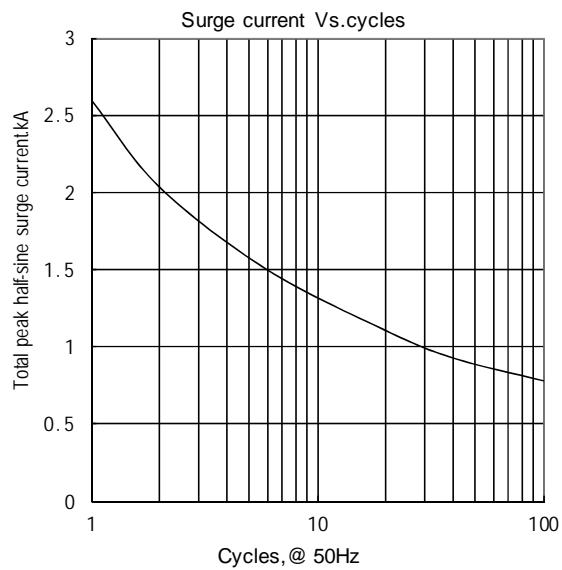


Fig.7

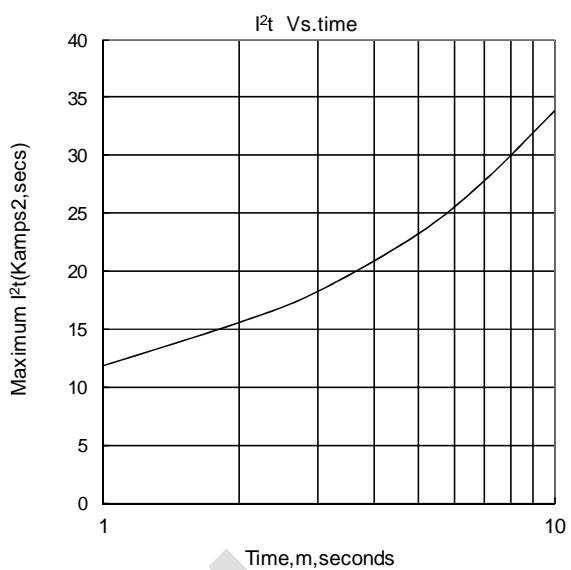
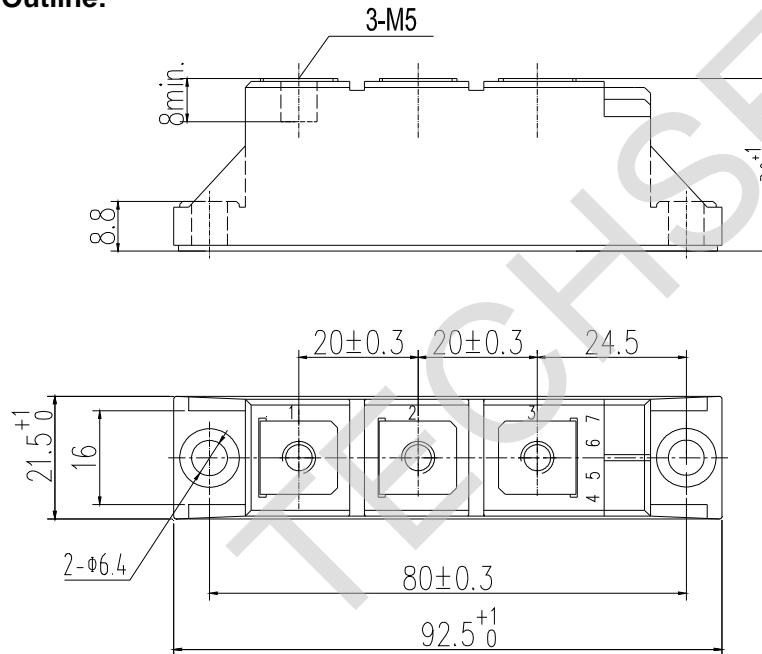


Fig.8

Outline:

Unmarked dimensional tolerance: ±0.5mm

